

MSP430F4250 Device Erratasheet

1 Functional Errata Revision History

Errata impacting device's operation, function or parametrics.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number DAC2 DAC3 FLL3 LCDA1 LCDA2 LCDA3 LCDA5	
DAC3 FLL3 LCDA1 LCDA2 LCDA3	′
FLL3 LCDA1 LCDA2 LCDA3	′
FLL3 LCDA1 LCDA2 LCDA3	′
LCDA2 V	,
LCDA3	′
LCDA5	′
LODINO	′
LCDA7	′
PORT6	′
SDA3	′
SDA6	′
SDA7	′
TA12 🗸	′
TA16	′
TA21 ✓	′
TAB22 ✓	′
WDG2	′

2 Preprogrammed Software Errata Revision History

Errata impacting pre-programmed software into the silicon by Texas Instruments.

✓ The check mark indicates that the issue is present in the specified revision.

The device doesn't have Software in ROM errata.

3 Debug only Errata Revision History

Errata only impacting debug operation.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev A
EEM20	1



4 Fixed by Compiler Errata Revision History

Errata completely resolved by compiler workaround. Refer to specific erratum for IDE and compiler versions with workaround.

✓ The check mark indicates that the issue is present in the specified revision.



Refer to the following MSP430 compiler documentation for more details about the CPU bugs workarounds.

TI MSP430 Compiler Tools (Code Composer Studio IDE)

- MSP430 Optimizing C/C++ Compiler: Check the --silicon_errata option
- MSP430 Assembly Language Tools

MSP430 GNU Compiler (MSP430-GCC)

- MSP430 GCC Options: Check -msilicon-errata= and -msilicon-errata-warn= options
- MSP430 GCC User's Guide

IAR Embedded Workbench

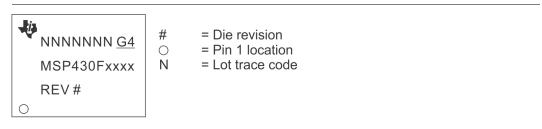
IAR workarounds for msp430 hardware issues



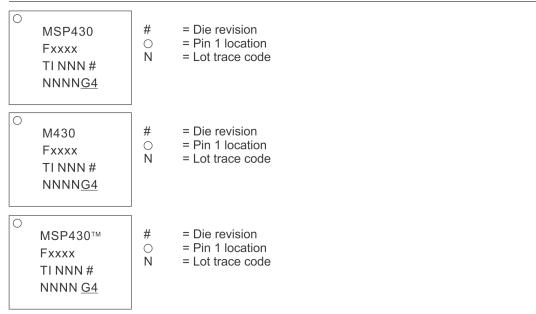
www.ti.com Package Markings

5 Package Markings

DL48 SOP (DL), 48 Pin



RGZ48 QFN (RGZ), 48 Pin



NOTE: Package marking with "TM" applies only to devices released after 2011.



6 Detailed Bug Description

CPU4 CPU Module

Category Compiler-Fixed

Function PUSH #4, PUSH #8CPU4 - Bug

Description The single operand instruction PUSH cannot use the internal constants (CG) 4 and 8.

The other internal constants (0, 1, 2, -1) can be used. The number of clock cycles is

different:

PUSH #CG uses address mode 00, requiring 3 cycles, 1 word instruction PUSH #4/#8 uses address mode 11, requiring 5 cycles, 2 word instruction

Workaround Refer to the table below for compiler-specific fix implementation information.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	IAR EW430 v2.x until v6.20	User is required to add the compiler flag option belowhw_workaround=CPU4
IAR Embedded Workbench	IAR EW430 v6.20 or later	Workaround is automatically enabled
TI MSP430 Compiler Tools (Code Composer Studio)	v1.1 or later	
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 4.9 build 167 or later	

DAC2 DAC12 Module

Category Functional

Function P1.4 GPIO function is not disabled when P1.4 = DAC0 output

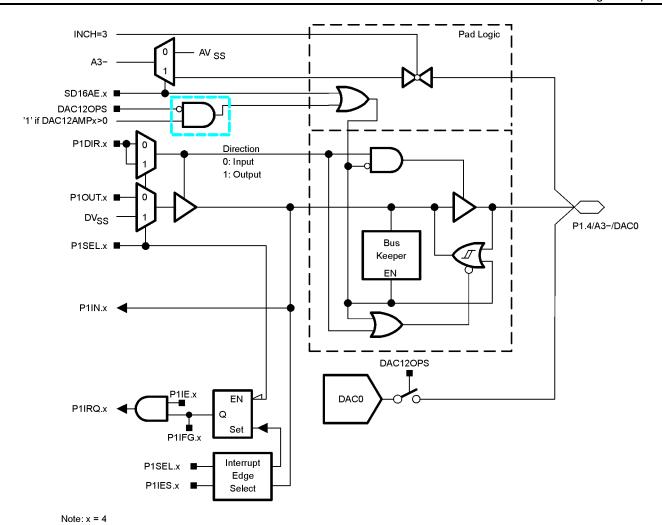
Description The DAC12OPS control bit used to automatically disable the P1.4 I/O logic is inverted as

shown in the figure below. When DAC12 is enabled (DAC12AMPx > 0) and

DAC12OPS=0, the port I/O for P1.4 will be disabled. Setting DAC12OPS = 1 to connect

the DAC12 output to P1.4 will erroneously enable the port GPIO logic.





Workaround

The P1.4 I/O logic should be disabled when the DAC12 is enabled using the SD16AE.4 analog enable bit. SD16AE.4=1 will disable the P1.4 I/O logic. The A3 SD16_A analog input cannot be used under this condition.

DAC3	DAC12 Module
DAU	DACIZ WOOTHE

Category Functional

Function Port P1.4 can not be used if DAC12 is internally enabled.

Description When DAC12 is enabled (DAC12AMPx > 0) and internal use is selected

(DAC12OPS=0), the P1.4 digital I/O functionality is disabled.

See also: DAC2 bug description.

Workaround None

EEM20 EEM Module

Category Debug



Function Debugger might clear interrupt flags

During debugging read-sensitive interrupt flags might be cleared as soon as the Description

debugger stops. This is valid in both single-stepping and free run modes.

Workaround None.

FLL3 FLL+ Module

Functional Category

Function FLLDx = 11 for /8 may generate an unstable MCLK frequency

When setting the FLL to higher frequencies using FLLDx = 11 (/8) the output frequency Description

of the FLL may have a larger frequency variation (e.g. averaged over 2sec) as well as a lower average output frequency than expected when compared to the other FLLDx bit

settings.

Workaround None

LCDA1 LCD A Module

Functional Category

Function High voltage on LCD A pins.

When static LCD mode is selected, the charge pump does not work correctly. The Description

feedback loop within the charge pump is switched off. This can result in high voltages on

LCD A segment and common pins.

WARNING: Using the charge pump when static mode is selected may cause permanent

damage to the MSP430 device and/or the LCD.

Workaround None

LCDA2 LCD A Module

Functional Category

Floating segment S5 **Function**

Dedicated LCD segment S5 is floating when LCD_A is disabled: LCDON = 0. In this Description

case S5 should be connected to ground.

Workaround None

LCDA3 LCD_A Module

Functional Category

Charge pump voltage **Function**

Description The charge pump output voltage has an offset of approximately -200 mV. This reduces

the LCD voltage levels specified in the datasheet for LCD. A by the same amount and

should be accounted for when selecting a charge pump voltage. See actual values



below:

LCD_A

	PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	UNIT		
V _{CC(LCD)}	Supply voltage	Charge pump enabled (LCDCPEN = 1; VLCDx > 0000)		2.2		3.6	٧		
C _{LCD}	Capacitor on LCDCAP (see Note 1)	Charge pump enabled (LCDCPEN = 1; VLCDx > 0000)		4.7			μF		
I _{CC(LCD)}	Average supply current (see Note 2)	V _{LCD(typ)} =3V; LCDCPEN = 1; VLCDx= 1000, all segments on f _{LCD} = f _{ACLK} /32 no LCD connected (see Note 2) T _A = 25°C	2.2 V		3.8		μΑ		
f_{LCD}	LCD frequency					1.1	kHz		
		VLCDx = 0000			VCC				
		VLCDx = 0001			2.50				
V _{LCD}		VLCDx = 0010			2.56				
	LCD voltage	VLCDx = 0011		į	2.61				
		VLCDx = 0100			2.67				
		VLCDx = 0101			2.72				
		VLCDx = 0110			2.78				
		VLCDx = 0111			2.83				
		VLCDx = 1000			2.89				
		VLCDx = 1001			2.94				
		VLCDx = 1010			3.00				
		VLCDx = 1011			3.05				
		VLCDx = 1100			3.11				
		VLCDx = 1101			3.16				
		VLCDx = 1110			3.22				
		VLCDx = 1111		3.12	3.27	3.42			
R _{LCD}	LCD driver output impedance	V _{LCD} = 3V; LCDCPEN = 1; VLCDx = 1000, I _{LOAD} = ±10μA	2.2 V			10	kΩ		

NOTES: 1. Enabling the internal charge pump with an external capacitor smaller than the minimum specified might damage the device.

Workaround None

LCDA5 LCD_A Module

Category Functional

Function Wrong cycle time for first cycle of COMx/Sx signals

Description The time of the first cycle of COMx/Sx signals after enabling the LCD_A module is only

half of the selected value. All following cycles are correct

Workaround Not required, because it does not influence the LCD function.

LCDA7 LCD_A Module

Category Functional

Function Higher current consumption when using shared LCD ports as fast toggling outputs

^{2.} Connecting an actual display will increase the current consumption depending on the size of the LCD.



Description

If a shared LCD pin (segment or com line) is used as digital fast toggling output (f>10kHz) and the VLCD is >0V (BG enabled) the device current consumption increases with higher toggling frequencies.

Workaround

- 1. Do not use shared LCD pins as fast toggling outputs if an LCD is used.
- 2. Reduce the toggle frequency of the shared pin to <10kHz.

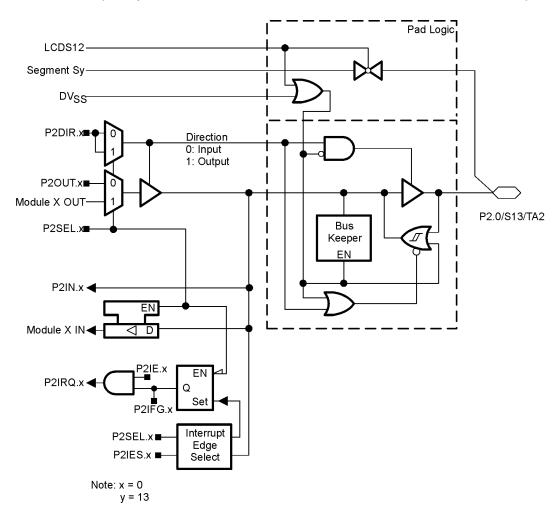
PORT6 PORT Module

Category Functional

Function P2.0 module function

Description

In addition to GPIO and LCD functionality, P2.0 also has Timer_A3 module output capability. When P2SEL.0 = 1 and P2DIR.0 = 1, P2.0 becomes a TA2 output.





PIN NAME (P2.X)	x	FUNCTION	CONTROL BITS / SIGNALS			
FIN NAME (F2.X)			P2DIR.x	P2SEL.x	LCDS12	
P2.0/S13/TA2	0	P2.0 Input/Output	0/1	0	0	
F2.0/313/1A2		N/A	0	1	0	
		Timer_A3.TA2	1	1	0	
		S13	X	X	1	

Workaround N/A

SDA3 SD16_A Module

Category Functional

Function The interrupt delay function can result in incorrect conversion data

Description The interrupt delay operation can result in incorrect conversion data when

SD16INTDLYx = 01, 10 or 11.

Workaround Use SD16INTDLYx = 00 setting (interrupt generated after fourth conversion). This

applies to the first conversion in Continuous mode and to each conversion in Single

mode.

SDA6 SD16_A Module

Category Functional

Function SD16CCTL0 write leads to unexpected results from SD16 A.

Description 1) No write attempt should be made to the register address 0x00B8 since it might lead to

malfunctioning of SD16A.

2) Bit-0 and bit-15 of register SD16CCTL0 should not be set as it might lead to

unexpected results from the SD16A.

Workaround None

SDA7 SD16_A Module

Category Functional

Function Reduced performance when input buffer is enabled.

Description The SD16_A performance is degraded if the high-impedance input buffer is enabled

(SD16CCTLx.SD16BUFx > 0) and the analog input voltage is in the range of AVSS to AVSS+0.2V. Avoid analog input voltages in this range when the high-impedance input

buffer is enabled.

Workaround None

TA12 TIMER A Module

Category Functional



Function Interrupt is lost (slow ACLK)

Description Timer_A counter is running with slow clock (external TACLK or ACLK)compared to

MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by one with the occurring compare interrupt (if TAR = CCRx). Due to the fast MCLK the CCRx register increment (CCRx = CCRx+1) happens before the Timer_A counter has incremented again. Therefore the next compare interrupt should happen at once with the next Timer_A counter increment (if TAR = CCRx + 1).

This interrupt gets lost.

Workaround Switch capture/compare mode to capture mode before the CCRx register increment.

Switch back to compare mode afterwards.

TA16 TIMER_A Module

Category Functional

Function First increment of TAR erroneous when IDx > 00

Description The first increment of TAR after any timer clear event (POR/TACLR) happens

immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK or TACLK). This is independent of the clock input divider settings (ID0, ID1). All following TAR increments are performed correctly with the selected IDx settings.

Workaround None

TA21 TIMER A Module

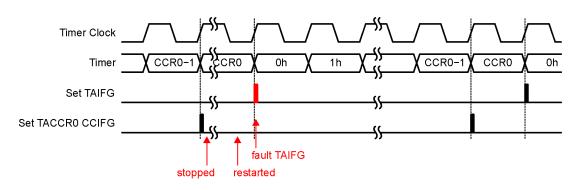
Category Functional

Function TAIFG Flag is erroneously set after Timer A restarts in Up Mode

Description In Up Mode, the TAIFG flag should only be set when the timer counts from TACCR0 to

zero. However, if the Timer A is stopped at TAR = TACCR0, then cleared (TAR=0) by setting the TACLR bit, and finally restarted in Up Mode, the next rising edge of the

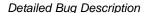
TACLK will erroneously set the TAIFG flag.



Workaround None.

TAB22 TIMER_A/TIMER_B Module

Category Functional





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Function Timer_A/Timer_B register modification after Watchdog Timer PUC

Description Unwanted modification of the Timer_A/Timer_B registers TACTL/TBCTL and TAIV/TBIV

can occur when a PUC is generated by the Watchdog Timer(WDT) in Watchdog mode

and any Timer_A/Timer_B counter register TACCRx/TBCCRx is

incremented/decremented (Timer_A/Timer_B does not need to be running).

Workaround Initialize TACTL/TBCTL register after the reset occurs using a MOV instruction (BIS/BIC

may not fully initialize the register). TAIV/TBIV is automatically cleared following this

initialization.

Example code:

MOV.W #VAL, &TACTL

or

MOV.W #VAL, &TBCTL

Where, VAL=0, if Timer is not used in application otherwise, user defined per desired

function.

WDG2 WDT Module

Category Functional

Function Incorrectly accessing a flash control register

Description If a key violation is caused by incorrectly accessing a flash control register, the watchdog

interrupt flag is set in addition to the expected PUC.

Workaround None



7 Document Revision History

Changes from family erratasheet to device specific erratasheet.

- 1. Errata SDA1 was removed
- 2. Errata SDA6 was added
- 3. Errata TAB22 was added
- 4. Errata SDA7 was added
- 5. Errata LCDA7 was added
- 6. Errata LCDA5 was added
- 7. RGZ48 package markings have been updated

Changes from device specific erratasheet to document Revision A.

1. Errata EEM20 was added to the errata documentation.

Changes from document Revision A to Revision B.

1. Errata TA21 was added to the errata documentation.

Changes from document Revision B to Revision C.

1. Package Markings section was updated.

Changes from document Revision C to Revision D.

1. TA21 Description was updated.

Changes from document Revision D to Revision E.

- 1. Function for CPU4 was updated.
- 2. Workaround for CPU4 was updated.

Changes from document Revision E to Revision F.

- 1. Erratasheet format update.
- 2. Added errata category field to "Detailed bug description" section

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